



Power MOSFETS

DATASHEET

LM4001NAK8A

N-Channel
Enhancement Mode MOSFET

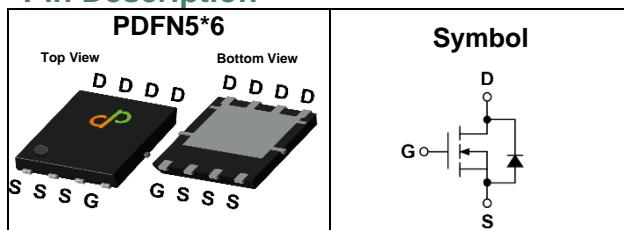
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- (03) 6577339 FAX : (03) 6577229
- www.leadpower-semi.com



Quality Management Systems
ISO 9001:2015 Certificate

N-Channel Enhancement Mode MOSFET

Pin Description



Product Summary

Symbol	N-Channel	Unit
V_{DSS}	40	V
$R_{DS(ON)-Max}$	1.4	$m\Omega$
ID	245	A

Feature

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- 100% UIS and R_g Tested
- Moisture Sensitivity Level MSL1

Applications

- DC-to-DC converters
- Switch Mode Power Supply
- Brushless DC motor control

Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM40013NAK8A	PDFN5*6	Tape & Reel	5000 / Tape & Reel	40013 □□□□□□

Note : □□□□□□ = Lot Code

Absolute Maximum Ratings ($T_J=25^\circ C$ Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit
V_{DSS}	Drain-Source Voltage	40	V
V_{GSS}	Gate-Source Voltage	± 20	
T_J	Maximum Junction Temperature	175	$^\circ C$
T_{STG}	Storage Temperature Range	-55 to 175	$^\circ C$
I_S	Diode Continuous Forward Current	$T_c=25^\circ C$	A
I_{DM}	Pulse Drain Current Tested	$T_c=25^\circ C$	$800^{\circ 1}$
I_D	Continuous Drain Current	$T_c=25^\circ C$	A
		$T_c=100^\circ C$	245
P_D	Maximum Power Dissipation	$T_c=25^\circ C$	115
		$T_c=100^\circ C$	58
I_D	Continuous Drain Current	$T_A=25^\circ C$	36
		$T_A=70^\circ C$	30
P_D	Maximum Power Dissipation	$T_A=25^\circ C$	2.5
		$T_A=70^\circ C$	1.8
$I_{AS}^{\circ 2}$	Avalanche Current, Single pulse	L=0.1mH	A
		L=0.5mH	48
$E_{AS}^{\circ 2}$	Avalanche Energy, Single pulse	L=0.1mH	25
		L=0.5mH	115
		L=0.1mH	156

Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JC}$	Thermal Resistance-Junction to Case	1.3	$^\circ C/W$
$R_{\theta JA}^{\circ 3}$	Thermal Resistance-Junction to Ambient	60	$^\circ C/W$

Note ① : Max. current is limited by bonding

Note ② : UIS tested and pulse width are limited by maximum junction temperature $150^\circ C$

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz

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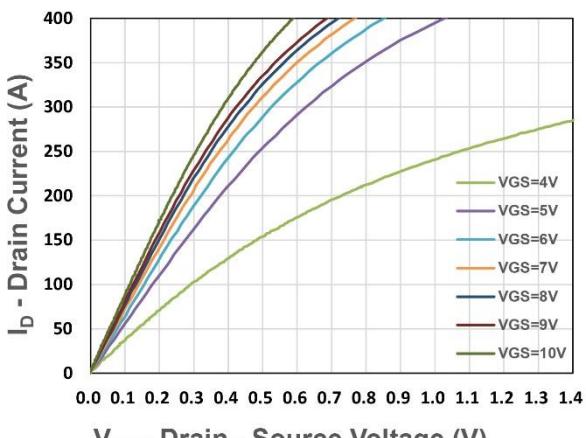
N-Channel Electrical Characteristics ($T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{DS}}=250\mu\text{A}$	40	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=32\text{V}$, $V_{\text{GS}}=0\text{V}$	-	-	1	μA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{DS}}=250\mu\text{A}$	1	1.7	2.3	V
I_{GSS}	Gate Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	-	-	± 100	nA
$R_{\text{DS(ON)}}^{\circledast}$	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}$, $I_{\text{DS}}=20\text{A}$	-	1.1	1.4	mΩ
		$V_{\text{GS}}=4.5\text{V}$, $I_{\text{DS}}=10\text{A}$	-	1.7	2.2	
g_{fs}	Forward Transconductance	$V_{\text{DS}}=5\text{V}$, $I_{\text{DS}}=10\text{A}$	-	46	-	S
Dynamic Characteristics ^⑤						
R_{G}	Gate Resistance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=0\text{V}$, Freq.=1MHz	-	1.3	-	Ω
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=20\text{V}$, Freq.=1MHz	-	4935	-	pF
C_{oss}	Output Capacitance		-	2000	-	
C_{rss}	Reverse Transfer Capacitance		-	68	-	
$t_{\text{d(ON)}}$	Turn-on Delay Time	$V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=20\text{V}$, $I_{\text{D}}=20\text{A}$, $R_{\text{GEN}}=3\Omega$	-	10.7	-	nS
t_{r}	Turn-on Rise Time		-	25.5	-	
$t_{\text{d(OFF)}}$	Turn-off Delay Time		-	65.5	-	
t_{f}	Turn-off Fall Time		-	54	-	
Q_{g}	Total Gate Charge	$V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=20\text{V}$, $I_{\text{D}}=20\text{A}$	-	70	-	nC
Q_{gs}	Gate-Source Charge		-	16.5	-	
Q_{gd}	Gate-Drain Charge		-	10	-	
Source-Drain Characteristics						
$V_{\text{SD}}^{\circledast}$	Diode Forward Voltage	$I_{\text{SD}}=10\text{A}$, $V_{\text{GS}}=0\text{V}$	-	0.8	1.1	V
t_{rr}	Reverse Recovery Time	$I_{\text{F}}=20\text{A}$, $V_{\text{R}}=20\text{V}$ $dI_{\text{F}}/dt=100\text{A}/\mu\text{s}$	-	49	-	nS
Q_{rr}	Reverse Recovery Charge		-	36	-	nC

Note ④ : Pulse test (pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$).

Note ⑤ : Guaranteed by design, not subject to production testing.

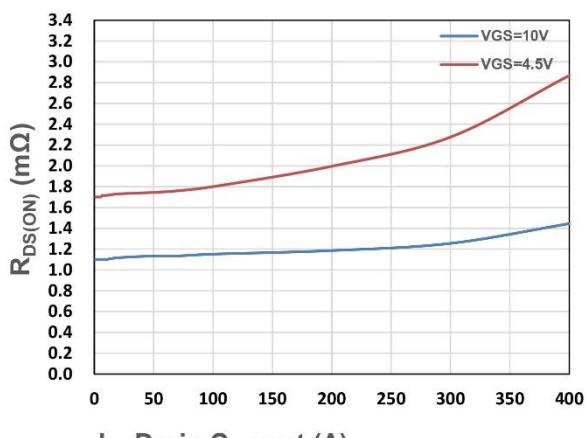
N-Channel Typical Characteristics



I_D - Drain Current (A)

V_{DS} - Drain - Source Voltage (V)

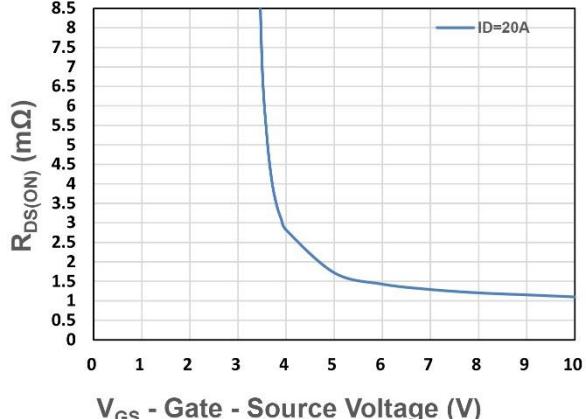
Figure 1. Output Characteristics



$R_{DS(ON)}$ (mΩ)

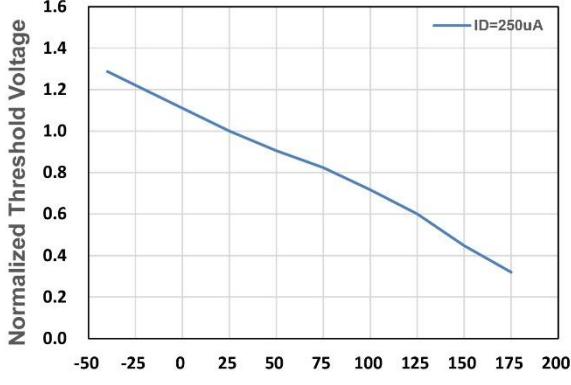
I_D - Drain Current (A)

Figure 2. On-Resistance vs. ID



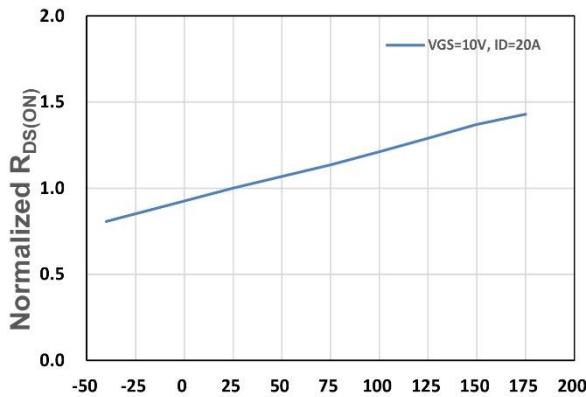
V_{GS} - Gate - Source Voltage (V)

Figure 3. On-Resistance vs. VGS



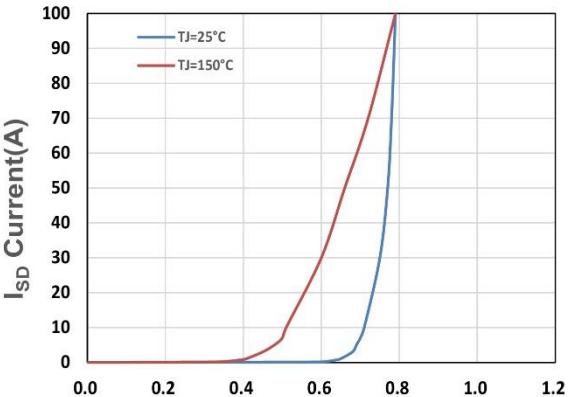
T_j , Junction Temperature(°C)

Figure 4. Gate Threshold Voltage



T_j , Junction Temperature(°C)

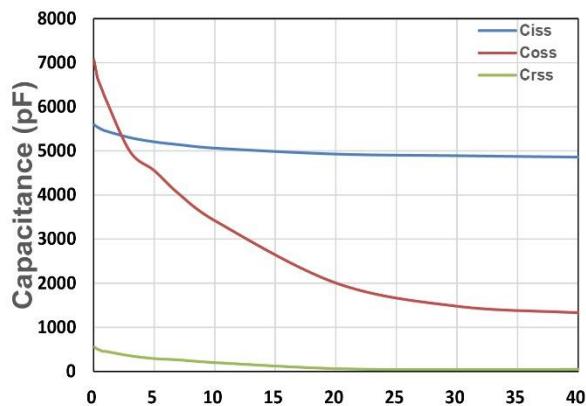
Figure 5. Drain-Source On Resistance



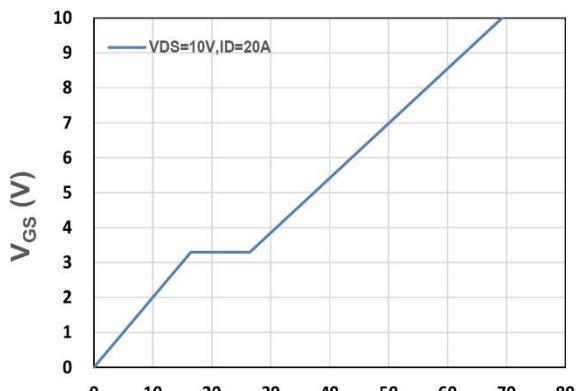
V_{SD} , Source-Drain Voltage(V)

Figure 6. Source-Drain Diode Forward

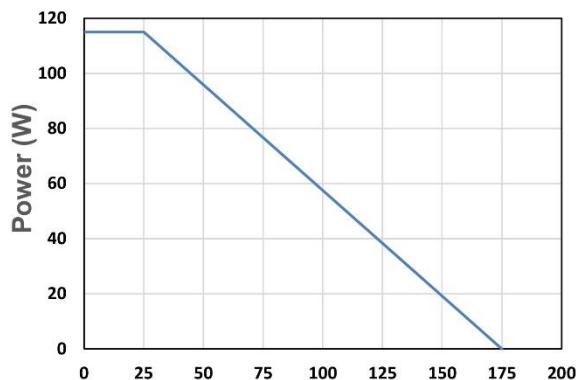
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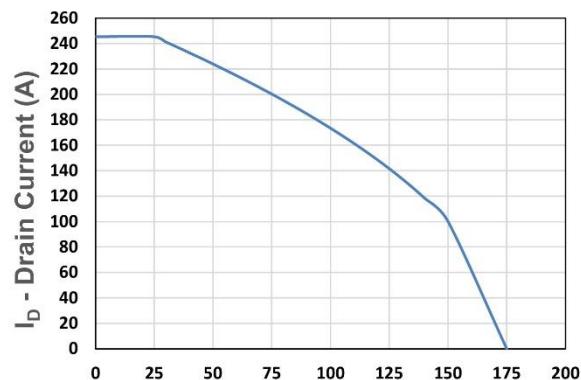
V_{DS} - Drain - Source Voltage (V)
Figure 7. Capacitance



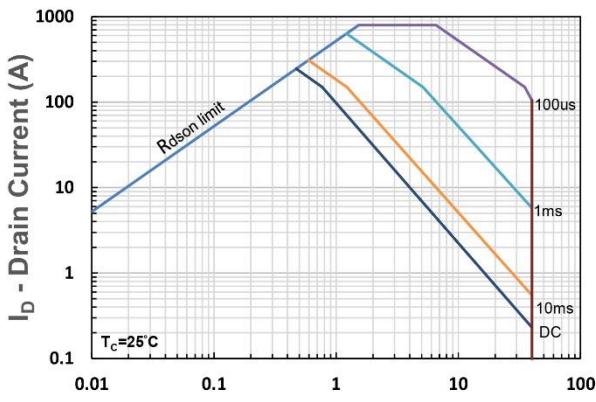
Q_g , Total Gate Charge (nC)
Figure 8. Gate Charge Characteristics



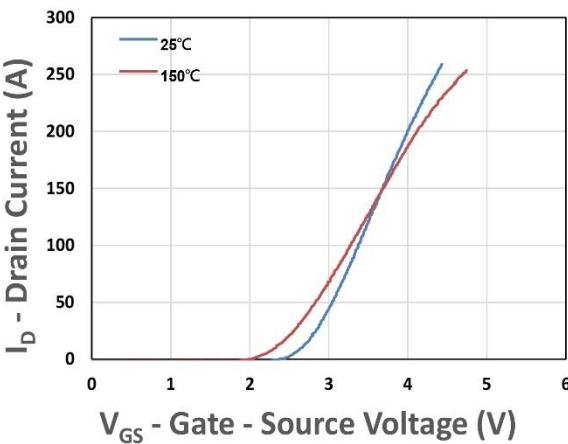
T_c - Case Temperature (°C)
Figure 9. Power Dissipation



I_D - Drain Current (A)
Figure 10. Drain Current



I_D - Drain Current (A)
 V_{DS} - Drain-Source Voltage (V)
Figure 11. Safe Operating Area



I_D - Drain Current (A)
 V_{GS} - Gate - Source Voltage (V)
Figure 12. Transfer Characteristics

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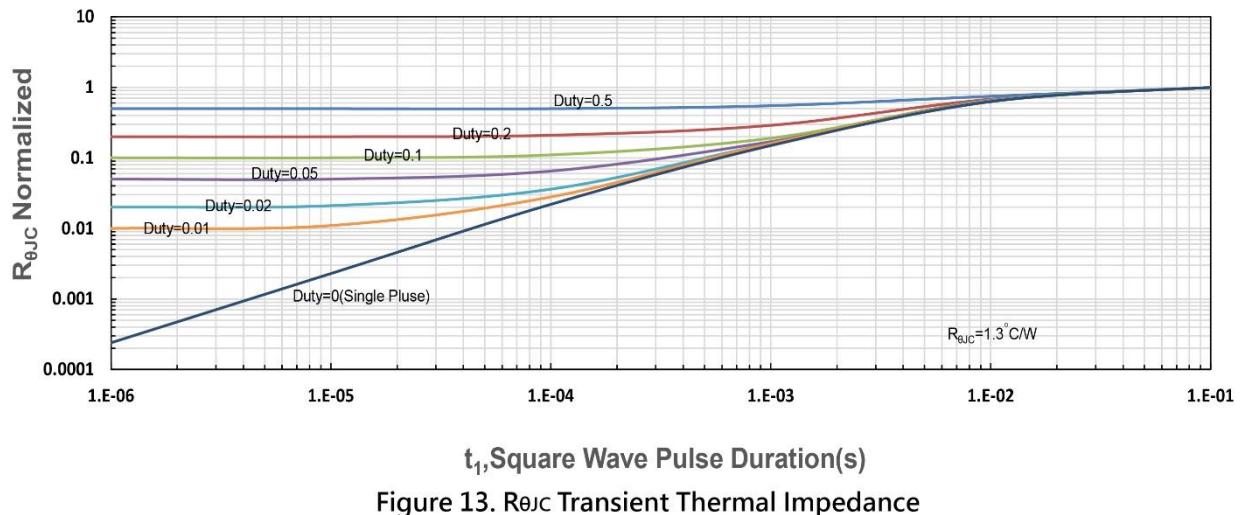


Figure 13. $R_{\theta JC}$ Transient Thermal Impedance